

# M-MOS Semiconductor Hong Kong Limited

## 30V N-Channel Enhancement-Mode MOSFET

 $V_{DS} = 30V$ 

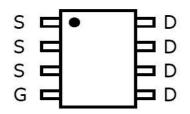
 $R_{DS(ON)}$ ,  $V_{gs}@10V$ ,  $I_{ds}@5.8A = 26m\Omega$ 

 $R_{DS(ON)}$ ,  $V_{gs}$ @4.5V,  $I_{ds}$ @5A = 40m $\Omega$ 

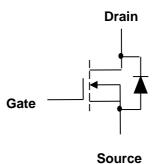
#### **Features**

Advanced trench process technology
High Density Cell Design For Ultra Low On-Resistance





**Internal Schematic Diagram** 



**Top View** 

**N-Channel MOSFET** 

### Maximum Ratings and Thermal Characteristics (T<sub>A</sub> = 25°C unless otherwise noted)

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		$V_{DS}$	30	V	
Gate-Source Voltage	$V_{GS}$	± 20			
Continuous Drain Current		I <sub>D</sub>	8.5	Α	
Pulsed Drain Current 1)		I <sub>DM</sub>	50		
Maximum Power Dissipation	TA = 25°C	P <sub>D</sub>	3	W	
	TA = 75°C		2.1		
Operating Junction and Storage Temperature Range		$T_J,T_stg$	-55 to 150	°C	
Junction-to-Case Thermal Resistance		$R_{ heta JC}$	24	°C/W	
Junction-to-Ambient Thermal Resistance (PCB mounted) 2)		$R_{ heta JA}$	62.5		

Note: 1. Repetitive Rating: Pulse width limited by the maximum junction temperature

2. 1-in<sup>2</sup> 2oz Cu PCB board

V 1.2



**Data Sheet** 

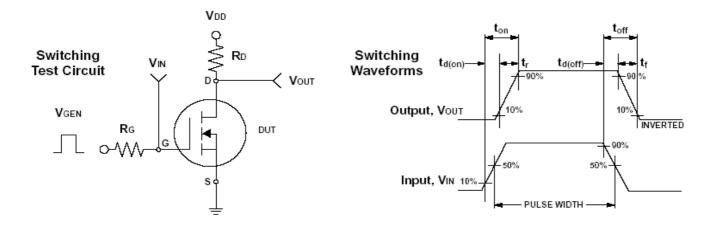
# **N-Channel Enhancement-Mode MOSFET**

#### **ELECTRICAL CHARACTERISTICS**

Symbol	Test Condition	Min	Тур	Max	Unit
BV <sub>DSS</sub>	$V_{GS} = 0V, I_D = 250uA$	30			V
R <sub>DS(on)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> =5.8A		20.0	26.0	mΩ
R <sub>DS(on)</sub>	$V_{GS} = 4.5V, I_D = 5A$		30.0	40.0	
$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 250uA$	1	1.5	3	V
I <sub>DSS</sub>	$V_{DS} = 30V, V_{GS} = 0V$			1	uA
I <sub>GSS</sub>	$V_{GS} = \pm 20V, V_{DS} = 0V$			± 100	nA
$Q_g$	$V_{DS} = 15V, I_{D} = 8.5A$ $V_{GS} = 10V$		7.58		nC
$Q_{gs}$			1.26		
$Q_{gd}$			1.66		
t <sub>d(on)</sub>	$V_{DD} = 15V, R_{L} = 15 \Omega$ $I_{D} = 1A, V_{GEN} = 10V$ $R_{G} = 6 \Omega$		10.12		ns ns
t <sub>r</sub>			3.12		
$t_{d(off)}$			22.16		
t <sub>f</sub>			2.96		
C <sub>iss</sub>	$V_{DS} = 15V, V_{GS} = 0V$ f = 1.0 MHz		390.07		pF
C <sub>oss</sub>			86.16		
C <sub>rss</sub>			59.31		
·					
I <sub>S</sub>				4.3	А
V <sub>SD</sub>	$I_S = 1A$ , $V_{GS} = 0V$			1	V
	BV <sub>DSS</sub>   R <sub>DS(on)</sub>   R <sub>DS(on)</sub>   V <sub>GS(th)</sub>   I <sub>DSS</sub>   I <sub>GSS</sub>   Q <sub>g</sub>   Q <sub>gs</sub>   Q <sub>gd</sub>   t <sub>d(on)</sub>   t <sub>r</sub>   t <sub>d(off)</sub>   t <sub>f</sub>   C <sub>iss</sub>   C <sub>oss</sub>   C <sub>rss</sub>   C <sub>rss</sub>	$ \begin{array}{ c c c } & BV_{DSS} & V_{GS} = 0V, \ I_D = 250uA \\ \hline & R_{DS(on)} & V_{GS} = 10V, \ I_D = 5.8A \\ \hline & R_{DS(on)} & V_{GS} = 4.5V, \ I_D = 5A \\ \hline & V_{GS(th)} & V_{DS} = V_{GS}, \ I_D = 250uA \\ \hline & I_{DSS} & V_{DS} = 30V, \ V_{GS} = 0V \\ \hline & I_{GSS} & V_{GS} = \pm 20V, \ V_{DS} = 0V \\ \hline \hline & Q_g & V_{DS} = 15V, \ I_D = 8.5A \\ \hline & Q_{gd} & V_{DS} = 15V, \ R_L = 15  \Omega \\ \hline & I_D = 1A, \ V_{GEN} = 10V \\ \hline & I_D = 1A, \ V_{GEN} = 10V \\ \hline & C_{iss} & V_{DS} = 15V, \ V_{GS} = 0V \\ \hline & C_{rss} & V_{DS} = 15V, \ V_{GS} = 0V \\ \hline & I_S & I_D = 15V, \ I_D = 15V, \ I_D = 10V \\ \hline & I_D = 10V \\ $	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

Note: Pulse test: pulse width <= 300us, duty cycle<= 2%

<sup>3.</sup> Guaranteed by design; not subject to production testing



V 1.2



### **Notice**

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V 1.2